

FDP032N08 N-Channel PowerTrench[®] MOSFET 75 V, 235 A, 3.2 m Ω

Features

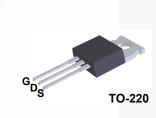
- $R_{DS(on)}$ = 2.5 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 75 A
- · Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

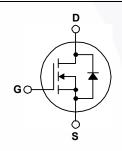
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor Drives and Uninterruptible Power Supplies





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

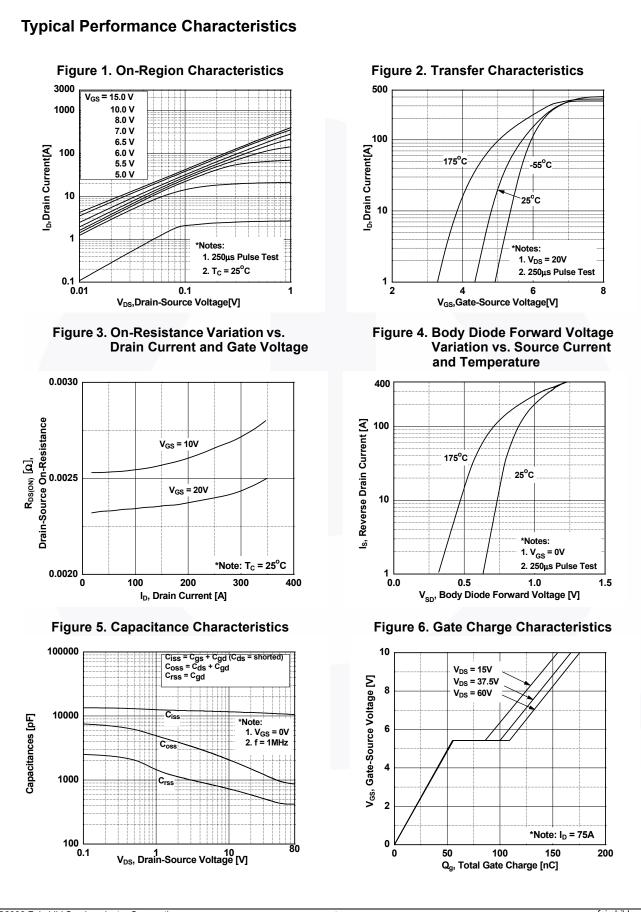
Symbol		Parameter		FDP032N08	Unit
V _{DSS}	Drain to Source Voltage			75	V
V _{GSS}	Gate to Source Voltage			±20	V
	Drain Current -	con Limited)	235	Α	
ID		con Limited)	165	Α	
	-	ckage Limited)	120	Α	
I _{DM}	Drain Current	- Pulsed	(Note 1)	940	Α
E _{AS}	Single Pulsed Avalanche I	(Note 2)	1995	mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	6.0	V/ns
P _D	Dower Dissinction	(T _C = 25 ^o C)		375	W
	Power Dissipation	- Derate Above 25°C		2.5	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +175	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C

Thermal Characteristics

Symbol	Parameter	FDP032N08	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.4	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	62.5	C/VV

November 2013

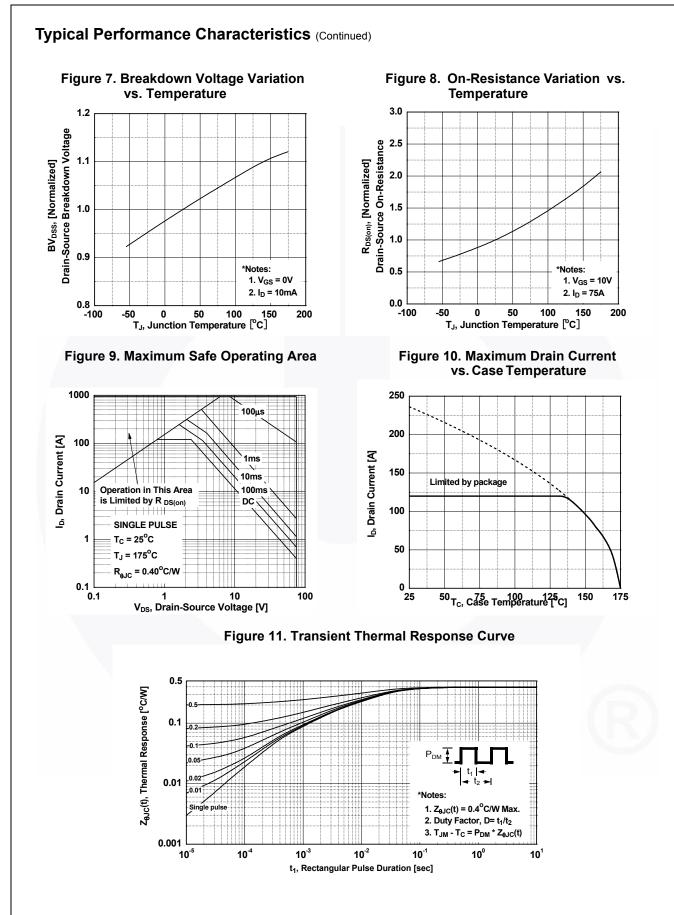
		Package	Packing Method	Reel Size	Тар	e Width	Qua	ntity	
		TO-220	Tube	N/A		N/A	50 units		
Electrica	l Chara	icteristics T _c = 25°C	C unless ot	herwise noted.					
Symbol		Parameter		Test Conditio	ons	Min.	Тур.	Max.	Unit
Off Charac	teristics								
BV _{DSS}	Drain to	Source Breakdown Voltage	In	₀ = 250 μA, V _{GS} = 0 V,	T _C = 25°C	75	-	-	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient			$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		-	0.05	-	V/ºC
I _{DSS}	Zero Gate Voltage Drain Current $V_{DS} = 75 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-	-	1	μA		
	0			$DS = 75 V, T_C = 150^{\circ}C$		-	-	500	
I _{GSS}	Gate to E	Body Leakage Current	V	$_{\rm GS}$ = ±20 V, V _{DS} = 0 V	·	-	-	±100	nA
On Charac	teristics								
V _{GS(th)}	Gate Thr	eshold Voltage	V	_{GS} = V _{DS} , I _D = 250 μA		2.5	3.5	4.5	V
R _{DS(on)}		ain to Source On Resistance		_{GS} = 10 V, I _D = 75 A		-	2.5	3.2	mΩ
9 _{FS}	Forward	Transconductance		_{DS} = 10 V, I _D = 75 A		-	180	-	S
Dynamic C	haracte	ristics							
C _{iss}	1	pacitance		V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		_	11400	15160	pF
C _{oss}		apacitance				_	1360	1810	pF
C _{rss}	-	Transfer Capacitance	f			-	595	800	pF
Q _{g(tot)}		e Charge at 10V	V			-	169	220	nC
Q _{gs}		Source Gate Charge		/ _{DS} = 60 V, I _D = 75 A, / _{GS} = 10 V	-		60	-	nC
Q _{gd}		Drain "Miller" Charge		63	(Note 4)	-	47	-	nC
Switching							220	470	
t _{d(on)}		Delay Time Rise Time	v	_{DD} = 37.5 V, I _D = 75 A		-	230	470	ns
t _r		Delay Time		$R_{G} = 25 \Omega, V_{GS} = 10 V$		-	191 335	392 680	ns
t _{d(off)}	Turn-Off			0	(Note 4)		121	252	ns ns
t _f					(Note 4)	-	121	252	113
		e Characteristics	<u> </u>						
ls		Continuous Drain to Source				-	-	235	A
I _{SM}		Pulsed Drain to Source Di				-	-	940	A
V _{SD}		Source Diode Forward Volta		00 05		-	-	1.3	V
t _{rr}		Recovery Time		V _{GS} = 0 V, I _{SD} = 75 A, dI _F /dt = 100 A/μs		-	53	-	ns
Q _{rr}	Reverse	Recovery Charge	u	$F/dt = 100 A/\mu s$		-	77	-	nC

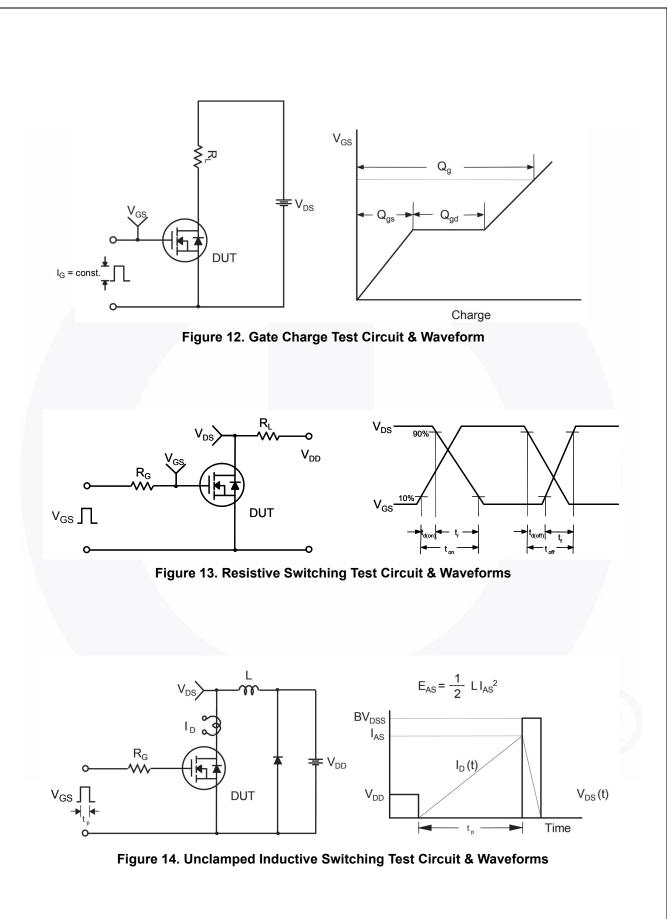


©2008 Fairchild Semiconductor Corporation FDP032N08 Rev. C2

3

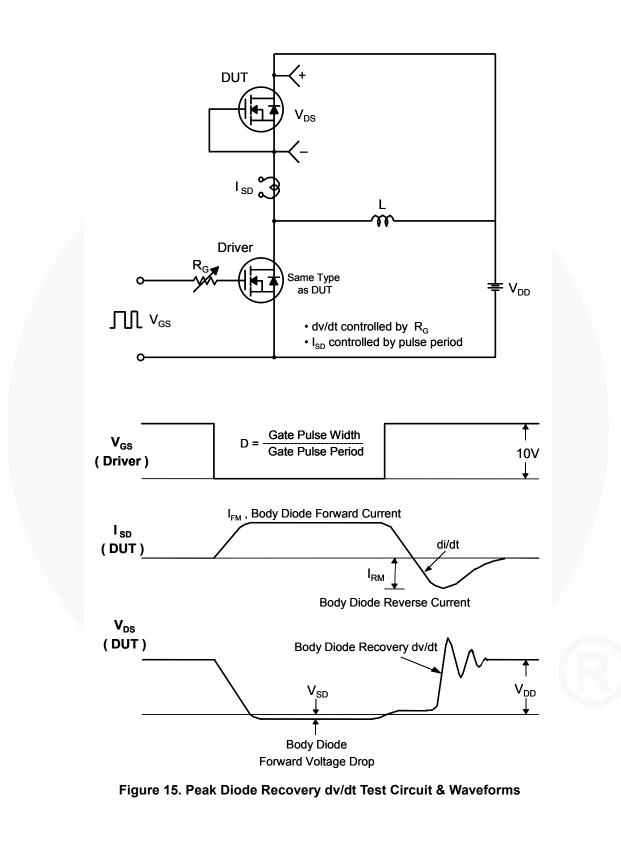


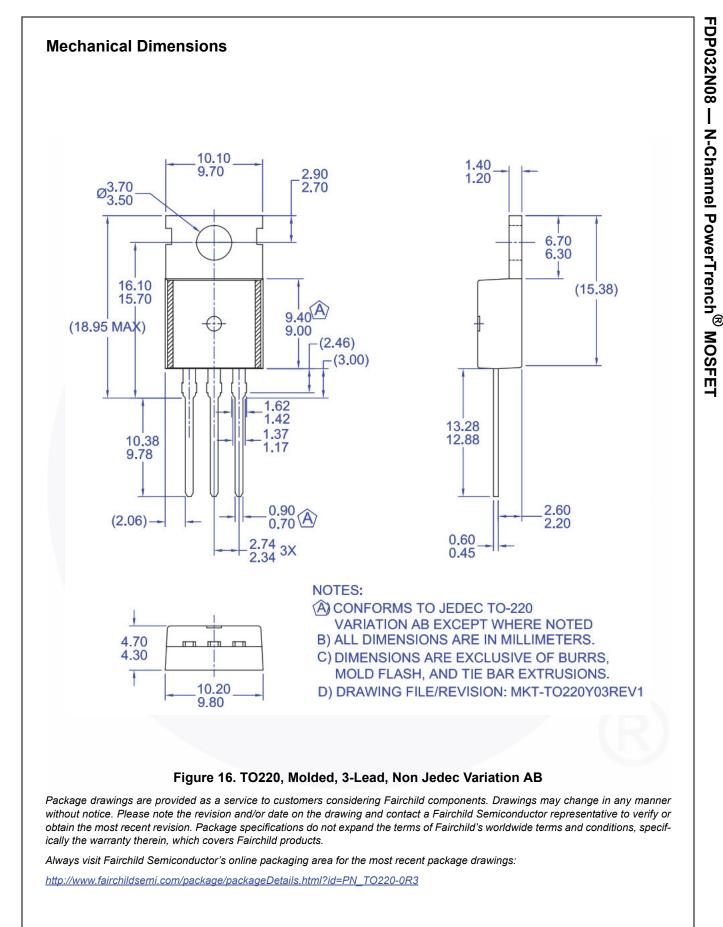




FDP032N08 — N-Channel PowerTrench[®] MOSFET

FDP032N08 — N-Channel PowerTrench[®] MOSFET







SEMICONDUCTOR

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™ F-PFS™	Sync-Lock™
AX-CAP®*FRFET® \bigcirc ®BitSiCTMGlobal Power ResourceSMPowerTrench®Build it NowTMGreenBridgeTMPowerXSTMCorePLUSTMGreen FPSTMProgrammable ActivCorePOWERTMGreen FPSTM e-SeriesTMQFET®CROSSVOLTTMGmaxTMQSTMCTLTMGTOTMQuiet SeriesTM	ve Droop™ TinyBoost® TinyBocst® TinyCalc™ TinyLogic®
Current Transfer Logic™IntelliMAX™RapidConfigure™DEUXPEED®ISOPLANAR™ISOPLANAR™Dual Cool™Marking Small Speakers Sound Louderつ™	mW/W/kW at a time [™] TinyPOPTO [™] TinyPOWer [™] TinyPWM [™] TranSiC [™] TriFault Detect [™] TRUECURENT [®] * µSerDes [™] UHC [®] Ultra FRFET [™] VGX [™] VisualMax [™] VoltagePlus [™] XS [™]

*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used here in:

- Life support devices or systems are devices or systems which, (a) are 1 intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

FDP032N08 — N-Channel PowerTrench[®] MOSFE1

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor: <u>FDP032N08</u>